

DOCKET: CU-2417
Customer No. 26530

APR 06 2004
OFFICIAL PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application: Takahiro IJIMA et al.

Serial No.: 09/736,864

Filed: December 14, 2000

For: INTERCONNECTION SUBSTRATE
HAVING METAL COLUMNS COVERED BY A
RESIN FILM AND MANUFACTURING
METHOD THEREOF

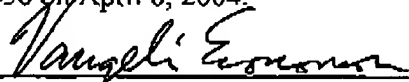
GRP ART UNIT : 2815

Ex.: CHU, C.

Issue Fee Due Date: 7/02/04

Certification under 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being transmitted by facsimile to the United States Patent and Trademark Office at the following facsimile number: (703) 872-9306, to the attention of Examiner C. Chu, and addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on April 6, 2004.


Vangelis Economou, Reg. No. 32,341

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER ALLOWNCE UNDER 37 C.F.R. § 1.312

Sir:

In response to the Office Action (Notice of Allowance, PTO L-85) dated April 2, 2004, please amend the above-identified application as follows:

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in this application: